

Rev. V1

Features

- Supports up to 20 W Power
- Low Insertion Loss 0.3 dB @ 2.7 GHz
- High Isolation 50 dB @ 2.7 GHz
- RoHS* Compliant

Description

A broadband, high linearity medium power series shunt switch element in a plastic 1.9 \times 1.1 mm DFN package.

This device is designed for WiMax, Wibro, WLAN, TD-SCDMA and other wireless infrastructure applications. It is also suited for $0.1 \sim 6$ GHz applications with up to 20 watts of power.



Electrical Specifications: $T_A = +25$ °C

Parameter	Test Conditions	Min.	Тур.	Max.	Units
Breakdown Voltage	I _R = 10 mA	100	_	_	V
Junction Capacitance	Shunt Series	_	0.05 0.14	_	pF
Series Resistance	Shunt Series	_	0.98 0.50	_	Ω
Lifetime	I _F = 10 mA, I _R = 10 mA , 50% Shunt Series	_	450 500	_	ns
I-Region	Shunt Series	_	15 15	_	μm
Insertion Loss	I = -50 mA ¹ F = 2.3 ~ 2.7 GHz F = 60 GHz	_	0.3 0.6	0.5 0.8	dB
Input Return Loss	I = -50 mA ¹ F = 2.3 ~ 2.7 GHz F = 60 GHz	15 10	21 13	_	dB
Output Return Loss	I = -50 mA ¹ F = 2.3 ~ 2.7 GHz F = 60 GHz	15 10	22 13	_	dB
Isolation	I = -50 mA ¹ F = 2.3 ~ 2.7 GHz F = 60 GHz	40 30	50 35	_	dB

^{1.} Positive current is defined as current going into pin 3.

^{*} Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.



Rev. V1

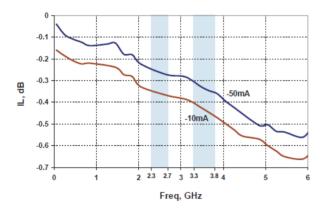
Absolute Maximum Ratings^{3,4}

Parameter	Absolute Maximum		
Breakdown Voltage	100 V		
Forward Current	100 mA		
Input Power	30 W CW		
Junction Temperature	+175°C		
Storage Temperature	-65°C to +150°C		
Solder Temperature	+260°C per JEDEC STD-J-20C		

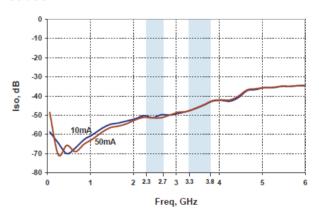
- 3. Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation near these survivability limits.

Typical RF Performance Curves @ +25°C

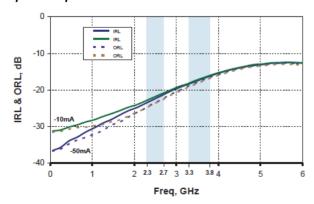
Insertion Loss



Isolation



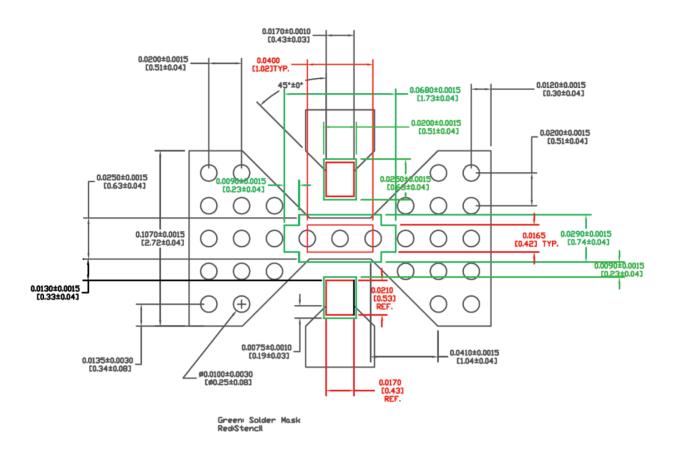
Input / Output Return Loss





Rev. V1

Printed Circuit Board Layout



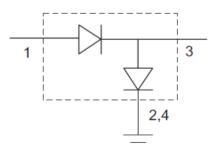
Assembly

If possible, use copper filled vias underneath pin 3 for better thermals; otherwise, use vias that are plated through, filled and plated over.

Solder mask should provide a 60 µm clearance between copper pad and solder mask underneath package and 125 µm clearance on outside edges of package. Rounded package pads should have matching rounded solder mask openings.

Use circles or squares for the thermal land stencil such that there is only 50% to 80% solder paste coverage.

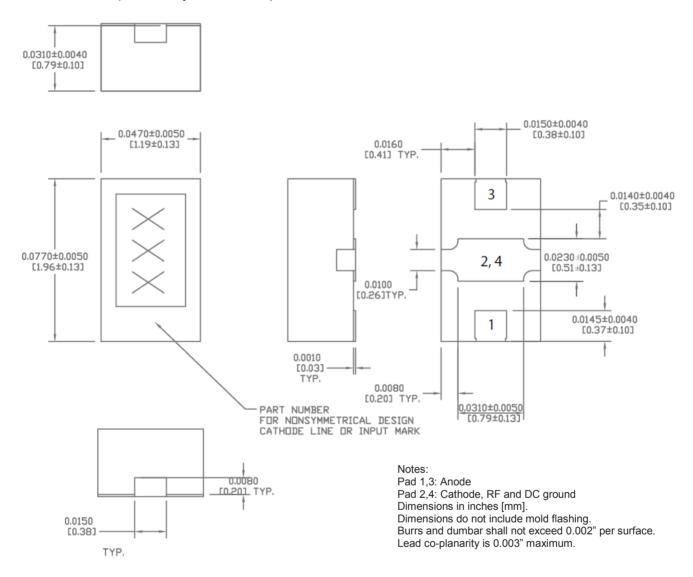
Electrical Schematic





Rev. V1

Outline: 2012 (molded plastic DFN)



MSWSS-020-40



PIN Diode Shunt Switch Element

Rev. V1

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